



2/17/2006

**PRODUCT RELIABILITY REPORT  
FOR**

**DS26521, Rev A1**

**Dallas Semiconductor**

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## Conclusion

The following qualification successfully meets the quality and reliability standards required of all Dallas Semiconductor products:

DS26521, Rev A1

In addition, Dallas Semiconductor's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at <http://www.maxim-ic.com/TechSupport/dsreliability.html>.

## Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at [http://dbserv.maxim-ic.com/l\\_datasheet3.cfm](http://dbserv.maxim-ic.com/l_datasheet3.cfm).

## Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

$$AfT = \exp((Ea/k)*(1/Tu - 1/Ts)) = tu/ts$$

AfT = Acceleration factor due to Temperature  
tu = Time at use temperature (e.g. 55°C)  
ts = Time at stress temperature (e.g. 125°C)  
k = Boltzmann's Constant (8.617 x 10<sup>-5</sup> eV/°K)  
Tu = Temperature at Use (°K)  
Ts = Temperature at Stress (°K)  
Ea = Activation Energy (e.g. 0.7 ev)

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

$$AfV = \exp(B*(Vs - Vu))$$

AfV = Acceleration factor due to Voltage  
Vs = Stress Voltage (e.g. 7.0 volts)  
Vu = Maximum Operating Voltage (e.g. 5.5 volts)  
B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

$$Fr = X/(ts * AfV * AfT * N * 2)$$

X = Chi-Sq statistical upper limit  
N = Life test sample size

Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

$$MTTF = 1/Fr$$

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

**FAILURE RATE:**                      **MTTF (YRS): 21277**                      **FITS: 5.4**

The parameters used to calculate this failure rate are as follows:

**Cf: 60%**                      **Ea: 0.7**                      **B: 0**                      **Tu: 25 °C**                      **Vu: 3.5 Volt**

The reliability data follows. At the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data. "\*" after DATE CODE denotes specific product

**Device Information:**

Process: 2P, 4M,0.35um,Sil.P1,P2Cap,Ti/TiN M1-M4,BPSG,Masked  
 Passivation: Passivation w/Nov TEOS Oxide-Nitride  
 Die Size: 0 x 0  
 Number of Transistors: 653896  
 Interconnect: Aluminum / 1% Silicon / 0.5% Copper  
 Gate Oxide Thickness: 75 Å

**ELECTRICAL CHARACTERIZATION**

DESCRIPTION	DATE COD	CONDITION	READPOINT	QTY	FAILS	FA#
ESD SENSITIVITY	0542 *	EOS/ESD S5.1 HBM 500 VOLTS	1 PUL'S	3	0	
ESD SENSITIVITY	0542 *	EOS/ESD S5.1 HBM 8000 VOLTS	1 PUL'S	3	0	
ESD SENSITIVITY	0542 *	EOS/ESD S5.1 HBM 1000 VOLTS	1 PUL'S	3	0	
ESD SENSITIVITY	0542 *	EOS/ESD S5.1 HBM 2000 VOLTS	1 PUL'S	3	0	
ESD SENSITIVITY	0542 *	EOS/ESD S5.1 HBM 4000 VOLTS	1 PUL'S	3	0	
ESD SENSITIVITY	0542 *	EOS/ESD S5.1 HBM 8000 VOLTS	1 PUL'S	3	0	
LATCH-UP	0542 *	JESD78, I-TEST 85C	2 DYS	6	0	
LATCH-UP	0542 *	JESD78, Vsupply TEST 125C	2 DYS	6	0	
<b>Total:</b>					<b>0</b>	

**OPERATING LIFE**

DESCRIPTION	DATE COD	CONDITION	READPOINT	QTY	FAILS	FA#
HIGH TEMP OP LIFE	0448	125C, 3.5 VOLTS	1000 HRS	45	0	
HIGH TEMP OP LIFE	0501	125C, 3.5 VOLTS	1000 HRS	45	0	
HIGH TEMP OP LIFE	0518	125C, 3.5 VOLTS	1000 HRS	45	0	
HIGH TEMP OP LIFE	0520	125C, 3.5 VOLTS	1000 HRS	44	0	
HIGH TEMP OP LIFE	0525	125C, 3.5 VOLTS	1000 HRS	77	0	

HIGH TEMP OP LIFE	0527	125C, 3.5 VOLTS	1000 HRS	45	0	
HIGH TEMP OP LIFE	0536	125C, 3.5V (PSA) & 2.0V (PSB)	500 HRS	45	0	
HIGH TEMP OP LIFE	0537	125C, 3.5 VOLTS	1000 HRS	45	1	No FA
HIGH TEMP OP LIFE	0542 *	125C, 3.5 VOLTS	192 HRS	45	0	
HIGH TEMP OP LIFE	0548	125C, 3.5 VOLTS	500 HRS	45	0	
			<b>Total:</b>		<b>1</b>	

**FAILURE RATE:                    MTTF (YRS): 21277                    FITS: 5.4**